

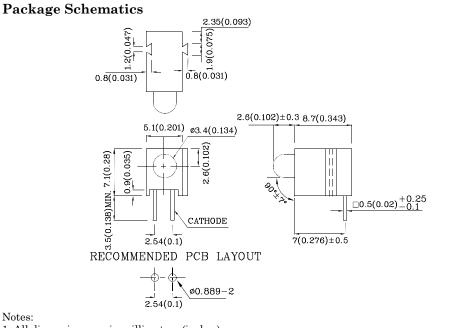
# Part Number: XPT1LUY41D

## 3.4mm RIGHT ANGLE LED INDICATOR

# **Features**

- Housing material: Type 66 Nylon
- Black casing provides superior contrast
- Housing UL rating: 94V-0
- $\bullet$  Reliable & robust
- RoHS Compliant





Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		UY (GaAsP/GaP)	Unit			
Reverse Voltage	$V_{\mathrm{R}}$	5	V			
Forward Current	$I_{\rm F}$	30	mA			
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{\rm FS}$	140	mA			
Power Dissipation	PD	75	mW			
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C			
Storage Temperature	Tstg	-40 ~ +85				
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds					
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds					

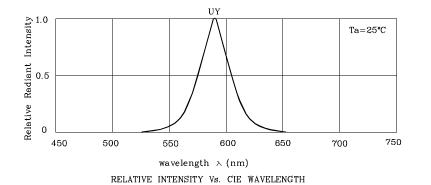
Operating Characteristics (T <sub>A</sub> =25°C)		UY (GaAsP/GaP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =10mA)	$V_{\mathrm{F}}$	1.95	V
Forward Voltage (Max.) (I <sub>F</sub> =10mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λP	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =10mA)	λD	588*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =10mA)	$ riangle\lambda$	35	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	pF

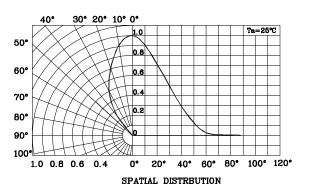
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =10mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XPT1LUY41D	Yellow	GaAsP/GaP	Yellow Diffused	8*	14*	590*	60°

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

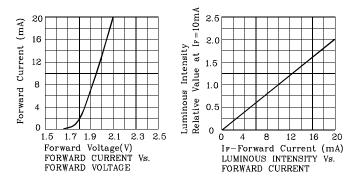
Dec 28,2013



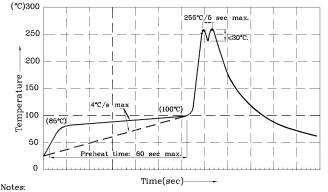




♦ UY



Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



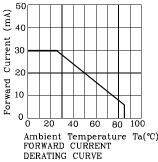
I.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of  $260^{\circ}$ C 2.Peak wave soldering temperature between  $245^{\circ}$ C ~  $255^{\circ}$ C for 3 sec

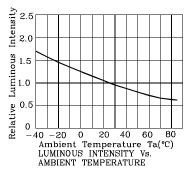
2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).

3.Do not apply stress to the epoxy resin while the temperature is above 85°C. 4.Fixtures should not incur stress on the component when mounting and during soldering process.

during soldering process. 5.SAC 305 solder alloy is recommended.

6.No more than one wave soldering pass.





#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

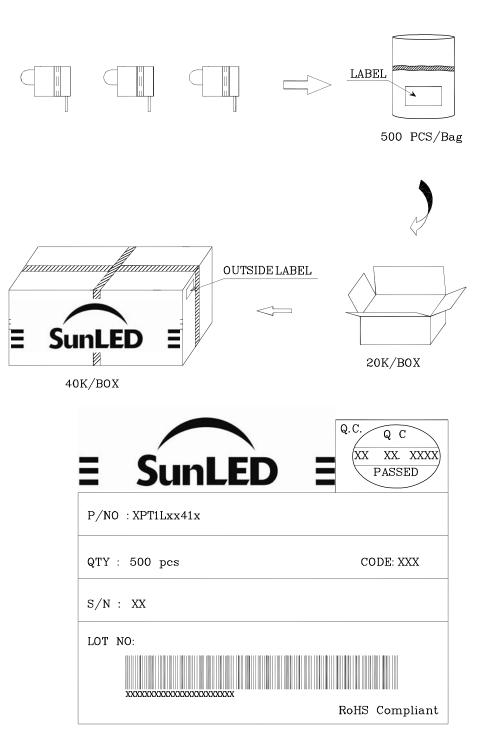
the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



**PACKING & LABEL SPECIFICATIONS** 



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